

# Service Manual Level 1-2 for Beng.mobile

A38



Release	Date	Department	Notes to change
R 1.0	05.07.2006	ISC S CES	New document

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 1 of 31



# **Table of Content**

1.	Key Feature	3
2.	Spare Part Overview of A38	4
3.	Disassembly of A38	6
4.	Assembly of A38	11
5.	BenQ Service Equipment User Manual	16
6.	Setup of the Software	18
7.	MCSD Tool User Guide	19
13.	JPICS (Java based Product Information Controlling System)	20
14.	International Mobile Equipment Identity, IMEI	25
15.	General Testing Information	26

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 2 of 31

# 1. Key Feature

System	<ul> <li>Tri-Band 900/1800/1900; 850/1800/1900</li> </ul>
Battery	Li-Ion 860 mAh
Stand – by Time	Up to 286 hrs.
Talking Time	• Up to 248 min.
Storage	• 256KB
Dimensions	<ul> <li>103.5 x 45.6 x 18.75mm</li> </ul>
Display	<ul> <li>Dithering 60.5K colours, 1.4", CSTN</li> </ul>
Ring Tone	32 polyphonic melody
Connectivity	• RS232
Messaging	SMS, EMS

## Features

- SMS/EMS
- Headset Mono, PC Connectivity Toolkit, and PC Data Cable
- Display: 1.4 inches, 96 x 64 pixels, 60,543 colors
- 32-chord polyphonic ringtones, MIDI, SP-MIDI, i-Melody
- Speaker and Receiver
- Baseband Solution: TI

## **Data Service**

- Baseband Solution: TI
- SMS, EMS
- Input: iTap

## SIM Functionality/Security Controls

- STK, SIM Lock / Security boot loader



Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 3 of 31



# 2. Spare Part Overview of A38

## **Overview Upper Parts**



No.	Description CM	Order Number
1.	Upper Case Shell (ASSY FRONT CASE)	
2.	RF Control Board incl. Display Module (PCBA MAIN BD)	
3.	Keypad	L50658-A218-A2-1
4.	Screws	L50658-A218-C90
5.	Earpiece (RECEIVER)	L50612-Z3-C86
6.	Microphone (MIC)	L50654-Z6-C125

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 4 of 31



## **Overview Lower Parts**



No.	Description CM	Order Number
7.	Lower Case Shell (ASSY REAR CASE)	
8.	Battery Cover (COVER BATTERY)	C39158-A218-B500
9.	Battery (BAT LI 3.7V)	V30145-K1310-X481
10.	Ringer (SPK D15 0.5W)	C39158-A218-C201
11.	Vibra-Alert (VIBRATOR)	C39453-Z5-C427

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 5 of 31

# 3. Disassembly of A38

All repairs as well as disassembling and assembling have to be carried out in an ESD protected environment and with ESD protected equipment/tools. For all activities the international ESD regulations have to be considered.

For more details please check information in c - market

## https://market.bengmobile.com/SO/welcome.lookup.asp

There you can find the document "ESD Guideline".



Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 6 of 31





Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 7 of 31



Ston 6	
Step 6	Remove screws with the Torque – Screwdriver. T5+
Step 7	
	Remove Lower Case Shell from the RF Control Board by using the Alternative Opening Tool very carefully.
Step 8	

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 8 of 31



Step 9	
	Remove Ringer by using Tweezers.
Step 10	
	Remove Vibrator by using Tweezers.
Step 11	Pomovo Kovpad by using
	Tweezers carefully.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 9 of 31



Step 12	
	Disconnect the Display Module and turn it up. <b>Do not remove the Display</b> <b>Module fully.</b>
Step 13	
	On the Back Side of the Display Module is the Earpiece. Remove it by using Tweezers carefully. Take care of the Flex Connection, it easily rips.
Step 14	
	Remove Microphone by using Tweezers.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 10 of 31



# 4. Assembly of A38

Step 1	
	Assemble Microphone.
Step 2	
	Assemble Earpiece.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 11 of 31



Step 3	
	Connect the Display Module with the RF Control Board.
Step 4	
	Assemble Keypad.
Step 5	
	Assemble Vibra-Alert.
Technical Documentation	Release 1.0

TD\_Repair\_L1-L2\_A38\_R1.0.pdf Page 12 of 31



Step 6	
	Assemble Ringer.
Step 7	
	Assemble RF Control Board and
	Lower Case Shell.
Step 8	
	Place screws by using the Torque – Screwdriver T5.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 13 of 31



Step 9	
	Remove the protection foil.
Step 10	
	Assemble Upper Case Shell and Lower Case Shell.
Step 11	
<complex-block></complex-block>	Assemble Battery.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 14 of 31



Step 12	
	Assemble Battery Cover.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 15 of 31



# 5. BenQ Service Equipment User Manual

## Introduction

Every LSO repairing BenQ handset must ensure that the quality standards are observed. BenQ has developed an automatic testing system that will perform all necessary measurements. This testing system is known as:

## **BenQ Mobile Service Equipment**

• For disassembling / assembling

Torque – Screwdriver Part Number: F 30032 – P 228 – A1
Opening tool (Case opening without destroying) Part Number: F 30032 – P 38 – A1
Alternative Opening tool Part Number: F30032 – P583 – A1
Tweezers

• For SW update



Technical Documentation	Release 1.0		
TD_Repair_L1-L2_A38_R1.0.pdf	Page 16 of 31		



• For testing

All mobile phones have to be tested with the GRT – Software. The service partner is responsible to ensure that all required hardware is available.

For additional Software and Hardware options as well as the supported GRT equipment, please check the GRT User manual.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 17 of 31



## 6. Setup of the Software

#### Download of the required software:

Download the driver, the MCSD Tool\_A38 software mobile software (core-software and language files) from the Technical Support Page:

## https://market.benqmobile.com/so/welcome.lookup.asp

### Installation of USB – Serial converter boot cable:

Start the "DataCableDrvInstaller.exe" file and follow the instructions of the installer.

Data Cable Driver Installer	
1. Please remove your USB data ca	able first.
2. Click "OK" to install, "Cancel" to a	abort.
OK Cance	1
DataCableDrvInstaller	
Driver installation OK ! Please plug-in the Data Cable !	to complete the installation.
ОК	1

Plug in the Data cable and follow the installation instructions to complete the process.

## Check the Comport number of the data cable in the device manager. (Tool supports only Comport 1 to 10)

### Installation of MCSD tool:

Start "setup.exe" file and follow the instructions.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 18 of 31



# 7. MCSD Tool User Guide

Press the HELP button to open the MCSD Tool User Guide.

File Settin	g View Mo	del Help									
Connect	Disconnect	Boot File	Mot File		<b>()))</b> Jatabase Ca	JR ble Loss	🤣 Help				
Beng	Beng	Beng	Beng	Beng	Beng	Benq	Beng	Beng	Beng	senq.	Be
											80
											30
											B
											B
											B
											B
											BO
											86
											80
											80
											B
											B
											B
											В.
sene											Ede

💕 MCSD Tool Help	
Ausblenden Zurück Drucken <u>O</u> ptioner	1
Inhalt Suchen	Welcome to use MCSD Tool

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 19 of 31



# 13. JPICS (Java based Product Information Controlling System)

🗿 JPICS PICS interne	et portal		Micros	oft Intern	et Explore	er bereitg	estellt von B	lenQ mobile Ka	mp-Lintfort		
	Ben Action	View	bile Extra	Window	Help				Global Home	My-BenQ	E-Mail
Benq.mobile	KLFS1D0C Version: JF	PICS_V5					Mask Username	: Login			16.11.2005 15:20
	Login										
						Username	SparkaJP			Aktu	Jalisieren
						Password					
								Login			
								ava ba			
Loading menu										<b>=([</b> ]]=  nol	t connected

## **Overview**

The following functions are available for the LSO:

- General mobile information
- Generate PINCODE
- Generate SIMLOCK UNLOCK Code
- Print IMEI labels

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 20 of 31

a JPICS PICS	S internet port	al Microsoft I	nternet Explo	rer bereit	gestellt von	BenQ mobile Kamp	o-Lintfort		
	ве	<b>nq</b> mobile					Global Home	My-BenQ	E-Mail
1	Action	JPICS user menu	View Extra	Window	Help				
Benq.m	obile Version:	)C JPICS_V5			Mask Username	SparkaJP			16.11.2005 15:20
Mobile info									
IMEI label print	ting								
Masterphone	codes								
Simlock unloc	k co								
BFBus - Status	,								
				Ghod	nse a fi	unation			
									connected

The access to the JPICS server which is located in Kamp – Lintfort is protected by chip card and in addition using secure socket layer (SSL) connection.

The JPICS server is only available for authorized users with a specially coded smart card. These smart cards and the administration of the JPICS web server and the PICS database – server can only be provided by the JPICS – TRUST – Center of the responsible department in Kamp – Lintfort.

In case of any questions or requests concerning smart cards or administration of the databases please ask your responsible BenQ Customer Care Manager.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 21 of 31



## Installation overview

The following installation description assumes that a web browser is already installed. JPICS is tested with the following browsers:

- 1. Internet Explorer Version 5.5 and higher
- 2. Netscape Version 6 and higher

For further information regarding supported browsers, browser version and supported operating systems, see the <u>Sun FAQ's</u>.

Here is a step by step instruction to install all the required components:

## It is necessary to follow this order!

- 1. Smart Card Reader (Omnikey: Cardman 2020 USB or Cardman 3121 USB)
- 2. CardOS interface (Siemens Version 3.0 B)
- 3. Java Runtime Environment (Sun)
- 4. Java additional components

# Every user is responsible for a proper installation matching the license agreements.

For installation and further access you need the following:

- 1. The JPICS Installation CD
- 2. The Smart Card JPICS.

<u>Remark:</u> We recommend using Cardman 2020 USB or Cardman 3121 USB. Serial card readers are not supported!!!

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 22 of 31



## **Generate Codes**

In the JPICS application you can choose to generate:

- Masterphone codes
- Simlock Unlock Codes

## **Masterphone codes**

The Masterphone code is used to unlock blocked mobiles.

**Masterphone codes** can only be supplied for mobiles which have been delivered in a regular manner.

🗿 JPICS PICS interne	t portal Microsoft Internet Explorer bereitgestellt von BenQ mobile Kamp	-Lintfort	
	Beng.mobile Action JPICS user menu View Extra Window Help	Global Home	My-BenQ E-Mail
Benq mobile	KLFS1D0C Mask Masterphone-Code* Version: 1.0 Username SparkaJP		16.11.2005 15:22
Mobile info	Troubleshooting Masterphone-Code Input IMET 351630000011691 Execute DBd ocation Kampd infort		
IMEI label printing Masterphone codes	Mobile data Producttype SL55 Deliverypartnumber L36880-N4910-A150-31		
Simlock unlock co BFBus - Status	SW version     000     Partnumber     \$30880-54910-A100-53       Warranty     Status     Normal		3155
	Delivery information Deliverynote LC00001579 Deliverydate 15.09.05 Mobile codes Mobile unlock code *#0003*40158737#		
			- connected

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 23 of 31

## Simlock – Unlock – Code

The **Simlock – Unlock – Codes** can only be generated if the following conditions are given:

- Mobile must have an active **Simlock** inside.
- The user must be given the authorization to obtain **Simlock Unlock Codes** for the variant of the operator to which the mobile was delivered last time.

🗿 JPICS PICS interne	et portal Microsoft Internet Explorer bereitgestellt von BenQ mobile Ka	amp-Lintfort 🖉 🗖 🔀
	BENQ mobile Action JPICS user menu View Extra Window Help	Global Home My-BenQ E-Mail
Beng mobile	KLFS1D0C Mask Simlock-Unlock-Code Version: 1.0 Username SparkaJP	16.11.2005 15:23
Mobile info IMEI label printing	Simlock-Unlock-Code Get information for given IMEI IMEI 350673547180612 Execute DB-Location Kamp-Lintfort	
Masterphone codes Simlock unlock co	Mobile data       Producttype     C45       Deliverypartnumber     L36880-55100-X139-15       SW version     049       Partnumber     S30880-55100-A139-14	
BFBus - Status	Warranty 21.08.05 Status Normal Delivery information	C45
	Deliverynote     0066015319     Deliverydate     22.08.03       Mobile codes     Network Mastercode	
	S. Providercode     S. Provider Mastercode       SIM-Mastercode     SIM-Reeanablecode       Corporatecode     Corporate Mastercode	
	Network Subnet Code   *#0004*2810115	8#

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 24 of 31



## 14. International Mobile Equipment Identity, IMEI

The mobile equipment is uniquely identified by the International Mobile Equipment Identity, IMEI, which consists of 15 digits. Type approval granted to a type of mobile is allocated 6 digits. The final assembly code is used to identify the final assembly plant and is assigned with 2 digits. 6 digits have been allocated for the equipment serial number for manufacturer and the last digit is spare.

A38 series IMEI label is accessible by removing the battery.

Re – use of IMEI label is possible by using a hair – dryer to remove the IMEI label.

Date code is shown on IMEI label: Detailed description on how to read date code is given in Annex 2.

To display the IMEI number, exit code and SW/HW version, key: \* # 300 # Code \*#301# activates self diagnosis.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 25 of 31



## **15. General Testing Information**

## **General Information**

The technical instruction for testing GSM mobile phones is to ensure the best repair quality.

## Validity

This procedure is to apply for all from BenQ mobile authorized level 2 up to 3 workshops.

## Procedure

All following checks and measurements have to be carried out in an ESD protected environment and with ESD protected equipment/tools. For all activities the international ESD regulations have to be considered.

## Get delivery:

- Ensure that every required information like fault description, customer data a.s.o. is available.
- Ensure that the packing of the defective items is according to packing requirements.
- Ensure that there is a description available, how to unpack the defective items and what to do with them.

## Enter data into your database:

(Depends on your application system)

- Ensure that every data, which is required for the IRIS-Reporting is available in your database.
- Ensure that there is a description available for the employees how to enter the data.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 26 of 31



## Incoming check and check after assembling:

### **!! Verify the customers fault description!!**

- After a successful verification pass the defective item to the responsible troubleshooting group.
- If the fault description can not be verified, perform additional tests to save time and to improve repair quality.
  - Switch on the device and enter PIN code if necessary unblock phone.
  - Check the <u>function</u> of all keys including side keys.
  - Check the display for error in line and row, and for illumination.
  - Check the **ringer/loudspeaker** acoustics by individual validation.
  - Perform a GSM Test as described on page 36.

### Check the storage capability:

- > Check internal resistance and capacity of the battery.
- > Check battery charging capability of the mobile phone.
- > Check charging capability of the power supply.
- > Check current consumption of the mobile phone in different mode.

### **Visual inspection:**

- > Check the entire board for liquid damages.
- > Check the entire board for electrical damages.
- > Check the housing of the mobile phone for damages.

### SW update:

Carry out a software update and data reset according to the master tables and operator/customer requirements.

### **Repairs:**

The disassembling as well as the assembling of a mobile phone has to be carried out by considering the rules mentioned in the dedicated manuals. If special equipment is required the service partner has to use it and to ensure the correct function of the tools.

If components and especially soldered components have to be replaced all rules mentioned in dedicated manuals or additional information e.g. service information have to be considered

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 27 of 31



GSM Test:

# With the availability of the GRT Test /Alignment software, this tool has to be used to perform the outgoing test!

>Connect the mobile/board via internal antenna (antenna coupler) and external antenna

(car cradle/universal antenna clip) to a GSM tester

>Use a Test SIM

For Triple Band phones use a separate test case, if the test software allows only one handover.

Skip the GSM Band test cases if not performed by the mobile phone

Example:	1. Test file	Band 1 = GSM900 / Band 2 = G	SM1800
	2. Test file	Band 1 = GSM1900	

Inte	Internal Antenna			
Test	case	Parameter	Measurements	Limits
1	Location Update	• GSM Band 1 • BS Power = -55 dBm • middle BCCH	Display check	• individual check
2	Call from BS	<ul> <li>low TCH</li> <li>highest PCL</li> <li>BS Power = -75 dBm</li> <li>middle BCCH</li> </ul>	Ringer/Loudspeaker check	• individual check
3	TX GSM Band 1	<ul> <li>low TCH</li> <li>highest PCL</li> <li>BS Power = -75 dBm</li> <li>middle BCCH</li> </ul>	<ul> <li>Frequency Error</li> <li>Phase Error RMS</li> <li>Phase Error Peak</li> <li>Average Power</li> <li>Power Time Template</li> </ul>	• GSM Spec.
4	Handover to GSM Band 2 Including Handover Check			
5	TX GSM Band 2	<ul> <li>low TCH</li> <li>highest PCL0</li> <li>BS Power = -75 dBm</li> <li>middle BCCH</li> </ul>	<ul> <li>Frequency Error</li> <li>Phase Error RMS</li> <li>Phase Error Peak</li> <li>Average Power</li> <li>Power Time Template</li> </ul>	• GSM Spec.
6	Call release from BS			

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 28 of 31



External Antenna				
7	Call from MS	• GSM900 • high TCH • second highest PCL • BS Power = -75 dBm • middle BCCH	Keyboard check	• individual check
8	TX GSM Band 1	<ul> <li>high TCH</li> <li>second highest PCL</li> <li>BS Power = -75 dBm</li> <li>middle BCCH</li> </ul>	<ul> <li>Frequency Error</li> <li>Phase Error RMS</li> <li>Phase Error Peak</li> <li>Average Power</li> <li>Power Time Template</li> </ul>	• GSM Spec.
9	RX GSM Band 1	<ul> <li>high TCH</li> <li>BS Power = -102 dBm</li> <li>50 Frames</li> <li>middle BCCH</li> </ul>	RX Level     RX Qual     BER Class Ib     BER Class II     BER Erased Frames	• GSM Spec.
10	Handover to GSM Band 2 Including Handover Check			
11	TX GSM Band 2	<ul> <li>high TCH</li> <li>second highest PCL</li> <li>BS Power = -75 dBm</li> <li>middle BCCH</li> </ul>	<ul> <li>Frequency Error</li> <li>Phase Error RMS</li> <li>Phase Error Peak</li> <li>Average Power</li> <li>Power Time Template</li> </ul>	• GSM Spec.
12	RX GSM Band2	<ul> <li>high TCH</li> <li>BS Power = -102 dBm</li> <li>50 Frames</li> <li>middle BCCH</li> </ul>	RX Level     RX Qual     BER Class Ib     BER Class II     BER Erased Frames	• GSM Spec.
13	Call release from MS			

## **Final Inspection:**

The final inspection contains:

- 1) A 100% network test (location update, and set up call).
- 2) Refer to point 3.3.
- 3) A random sample checks of:
  - Data reset (if required)
  - Optical appearance
  - complete function

4) Check if PIN-Code is activated (delete the PIN-Code if necessary).
Basis is the international standard of **DIN ISO 2859**.
Use Normal Sample Plan Level II and the Quality Border 0,4 for LSO. **Remark**: All sample checks must be documented.

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 29 of 31



# Annex 1

**Test SIM Card** 

There are two different "Test SIM Cards" in use:

1) Test SIM Card from the company "ORGA"

Pin 1 number:	0000
PUK 1  :	12345678
Pin 2 number:	0000

PUK 2	:	23456789

2) Test SIM Card from the company "T-D1"

Pin 1 number:	1234
PUK :	76543210
Pin 2 number:	5678
PUK 2 :	98765432

Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 30 of 31



# Annex 2

## **Device Date Code overview**

GSN rule: (ex: GS11500001TG0)

GS19500001TG0Big classDateMonthYearS/NFactory

Code	Meaning	Content
D	Date	1~9, A=10, B=11, C=12, D=13, E=14, F=15, G=16, H=17, J=18, K=19, L=20, M=21, N=22, P=23, R=24, S=25, T=26, V=27, W=28, X=29, Y=30, Z=31 (Don't use: 0, I, O, Q, U)
М	Month	1=Jan, 2=Feb, 3=Mar, 4=Apr, 5=May, 6=Jun, 7=Jul, 8=Aug, 9=Sep, A=Oct., B=Nov, C=Dec
Y	Year	Last digit of Year (Christian era) ex. Year 2004 → "4"

Based on the definition above, GSC55... below means 2005/05/12.



Technical Documentation	Release 1.0
TD_Repair_L1-L2_A38_R1.0.pdf	Page 31 of 31